

GD4027B

DUAL JK FLIP-FLOP

DESCRIPTION — The 4027B is a Dual JK Flip-Flop which is edge-triggered and features independent Direct Set, Direct Clear, and Clock inputs. Data is accepted when the Clock is LOW and transferred to the output on the positive-going edge of the Clock. The active HIGH asynchronous Clear Direct (C_D) and Set Direct (S_D) are independent and override the J, K, or Clock inputs. The outputs are buffered for best system performance.

PIN NAMES

J, K	Synchronous Inputs
CP	Clock Input (L → H Edge-Triggered)
S_D	Asynchronous Direct Set Input (Active HIGH)
C_D	Asynchronous Direct Clear Input (Active HIGH)
Q	True Output
\bar{Q}	Complement Output

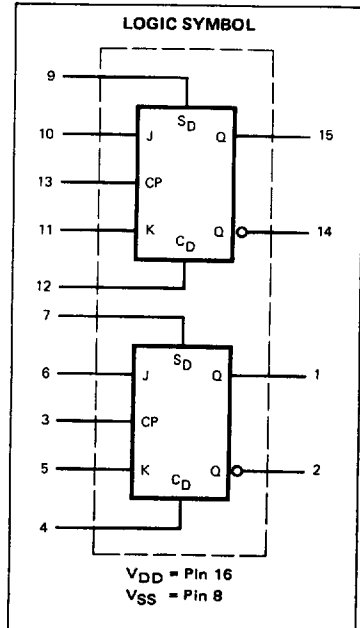
TRUTH TABLES

ASYNCHRONOUS INPUTS		OUTPUTS	
S_D	C_D	Q	\bar{Q}
L	H	L	H
H	L	H	L
H	H	H	H

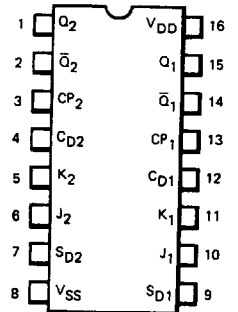
L = LOW Level
H = HIGH Level
↗ = Positive-Going Transition
 Q_{n+1} = State After Clock Positive Transition

SYNCHRONOUS INPUTS			OUTPUTS	
CP	J	K	Q_{n+1}	\bar{Q}_{n+1}
↗	L	L	NO CHANGE	
↗	H	L	H	L
↗	L	H	L	H
↗	H	H	\bar{Q}_n	Q_n

Conditions: $S_D = C_D = \text{LOW}$



CONNECTION DIAGRAMS DIP (TOP VIEW)



NOTE:
The SO Package has the same pinouts (Connection Diagram) as the Dual In-line Package.

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DC CHARACTERISTICS: V_{DD} as shown, $V_{SS} = 0$ V (See Note 1)

SYMBOL	PARAMETER	LIMITS								UNITS	TEMP	TEST CONDITIONS		
		$V_{DD} = 5$ V			$V_{DD} = 10$ V			$V_{DD} = 15$ V						
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP				MAX	
I_{DD}	Quiescent Power Supply Current	XC			4			8			16	μ A	MIN, 25°C	All inputs at 0 V or V_{DD}
					30			60			120		MAX	
					1			2			4		MIN, 25°C	
		XM			30			60			120	μ A	MAX	

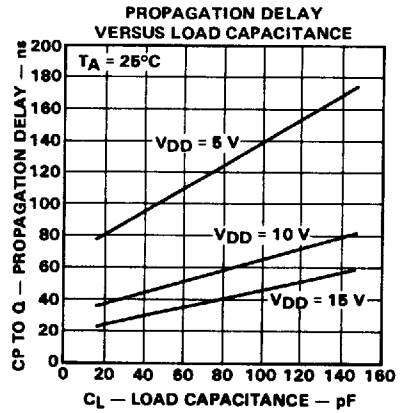
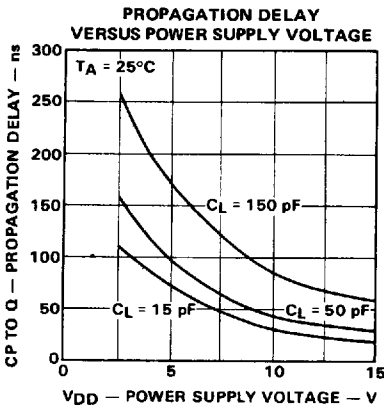
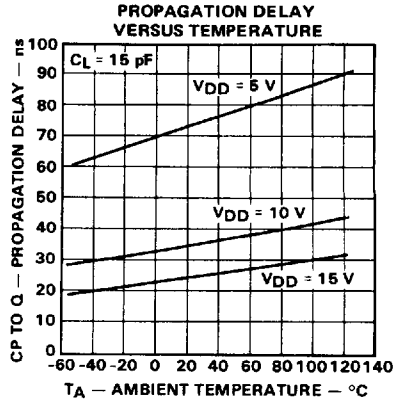
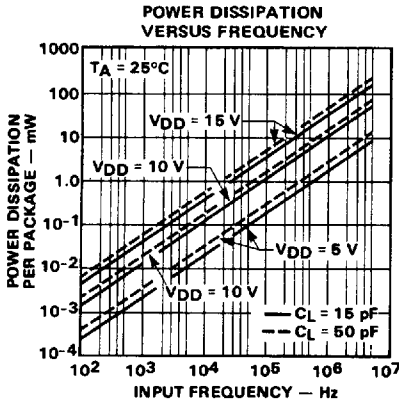
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: V_{DD} as shown, $V_{SS} = 0$ V, $T_A = 25^\circ$ C (See Note 3)

SYMBOL	PARAMETER	LIMITS									UNITS	TEST CONDITIONS
		$V_{DD} = 5$ V			$V_{DD} = 10$ V			$V_{DD} = 15$ V				
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
t_{PLH}	Propagation Delay, CP to Q, \bar{Q}		100	200		45	85		30	68	ns	$C_L = 50$ pF, $R_L = 200$ k Ω Input Transition Times < 20 ns
t_{PHL}			100	200		45	85		30	68	ns	
t_{PLH}	Propagation Delay, S_D to Q		180	350		90	175		75	140	ns	
t_{PHL}	Propagation Delay, C_D to Q		180	350		90	175		75	140	ns	
t_{TLH}	Output Transition Time		85	150		45	85		30	50	ns	
t_{THL}			85	150		45	85		30	50	ns	
t_s	Set-Up Time, J, K to CP	100	45		40	20		32	15		ns	
t_h	Hold Time, J, K to CP	0	-25		0	-10		0	-5		ns	
$t_{wCP(L)}$	Minimum Clock Pulse Width	150	75		70	35		56	25		ns	
$t_{wSD(H)}$	Minimum S_D Pulse Width	150	75		60	30		48	25		ns	
$t_{wCD(H)}$	Minimum C_D Pulse Width	150	75		60	30		48	25		ns	
t_{recSD}	Recovery Time for S_D	0	-5		0	-4		0	-3		ns	
t_{recCD}	Recovery Time for C_D	0	-5		0	-4		0	-3		ns	
f_{MAX}	Maximum CP Frequency (Note 2)	4	8		8	16		9	19		MHz	

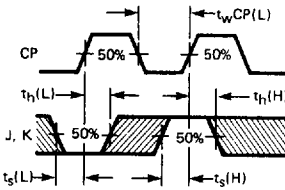
NOTES:

1. Additional DC Characteristics are listed in this section under 4000B Series CMOS Family Characteristics.
2. For f_{MAX} input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
3. Propagation Delays and Output Transition Times are graphically described in this section under 4000B Series CMOS Family Characteristics.
4. It is recommended that input rise and fall times to the Clock Input be less than 15 μ s at $V_{DD} = 5$ V, 4 μ s at $V_{DD} = 10$ V, and 3 μ s at $V_{DD} = 15$ V.

TYPICAL ELECTRICAL CHARACTERISTICS

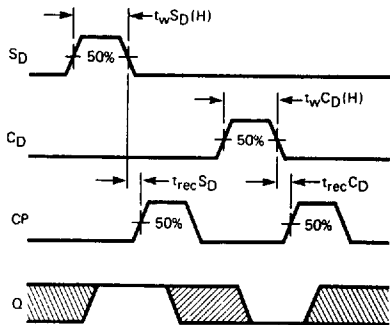


SWITCHING WAVEFORMS



NOTE:
 t_s & t_h are shown as positive values but may be specified as negative values.

SET-UP TIMES, HOLD TIMES,
 AND MINIMUM CLOCK PULSE WIDTH



RECOVERY TIME FOR SD, RECOVERY TIME FOR CD,
 MINIMUM SD PULSE WIDTH, AND MINIMUM CD PULSE WIDTH